

ON Semiconductor®

FAN53501 3MHz, 600mA Step-Down DC-DC Converter in Wafer-Level Chip-Scale Packaging

Features

- 3 MHz Fixed-Frequency Operation
- 16 µA Typical Quiescent Current
- 600 mA Output Current Capability
- 2.7 V to 5.5 V Input Voltage Range
- 1.82 V Fixed Output Voltage
- Synchronous Operation
- Pow er-Save Mode
- Soft-Start Capability
- Active Discharge During Shutdow n
- Input Under-Voltage Lockout (UVLO)
- Thermal Shutdow n and Overload Protection
- 5-Bump 1.00 x 1.37 mm WLCSP

Applications

- Cell Phones, Smart-Phones
- Pocket PCs
- WLAN DC-DC Converter Modules
- PDA, DSC, PMP, and MP3 Players
- Portable Hard Disk Drives

Description

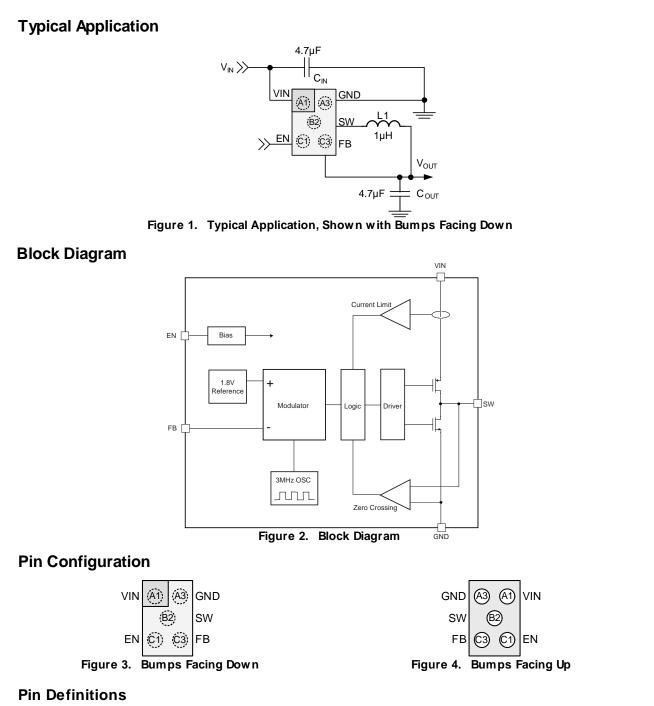
The FAN53501 is a step-down switching voltage regulator that delivers a fixed 1.82 V from an input voltage supply of 2.7 V to 5.5 V. Using a proprietary architecture with synchronous rectification, the FAN53501 is capable of delivering 600 mA at over 90% efficiency, while maintaining a very high efficiency of over 80% at load currents as low as 1 mA. The regulator operates at a nominal fixed frequency of 3 MHz at full load, which reduces the value of the external components to 1 μ H for the output inductor and 4.7 μ F for the output capacitor.

At moderate and light loads, pulse frequency modulation is used to operate the device in power-save mode with a typical quiescent current of 16 μ A. Even with such a low quiescent current, the part exhibits excellent transient response during large load swings. At higher loads, the system automatically switches to fixed-frequency control, operating at 3 MHz. In shutdow n mode, the supply current drops below 1 μ A, reducing pow er consumption.

The FAN53501 is available in a 5-bump Wafer-Level Chip-Scale Package (WLCSP).

Ordering Information

Part Number	Operating Temperature Range	Package	Packing Method
FAN53501UCX	-40°C to 85°C	5-Ball, Type-1, WL-CSP, 1x1.37mm, 0.5mm Pitch	Tape and Reel
FAN53501AUCX	-40 C 10 65 C	5-bail, Type-1, WE-CSF, 1X1.371111, 0.51111 FlC1	Tape and Reel



Pin #	Name	Description
A1	V _{IN}	Power Supply Input.
A3	GND	Ground Pin. Signal and pow er ground for the part.
C1	EN	Enable Pin . The device is in shutdow n mode when voltage to this pin is <0.4V and enabled when >1.2V. Do not leave this pin floating.
СЗ	FB	Feedback Analog Input. Connect directly to the output capacitor.
B2	SW	Switching Node. Connection to the internal PFET switch and NFET synchronous rectifier.

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol		Min.	Max.	Unit	
M	Input Voltage with Respect to GND		-0.3	6.0	V
V _{IN}	Voltage on Any Other Pin with	tage on Any Other Pin with Respect to GND			V
TJ	Junction Temperature		-40	+150	°C
T _{STG}	Storage Temperature		-65	+150	°C
TL	Lead Temperature (Soldering, 10 Seconds)			+260	°C
		Human Body Model, JESD22-A114	4.5		
ESD	Electrostatic Discharge Protection Level	Charged Device Model, JESD22-C101	1.5		kV
	Machine Model, JESD22-A115		200		V

Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. ON Semiconductor does not recommend exceeding them or designing to Absolute Maximum Ratings.

Symbol	Parameter	Min.	Тур.	Max.	Unit
V _{cc}	Supply Voltage Range	2.7		5.5	V
l _{out}	Output Current	0		600	mA
L	Inductor	0.7	1.0	3.0	μH
CIN	Input Capacitor	3.3	4.7	12.0	μF
C _{OUT}	Output Capacitor	3.3	4.7	12.0	μF
T _A	Operating Ambient Temperature	-40		+85	°C
TJ	Operating Junction Temperature	-40		+125	°C

Thermal Properties

Symbol	Parameter	Min.	Тур.	Max.	Units
Θ_{JA}	Junction-to-Ambient Thermal Resistance ⁽¹⁾		180		°C/W

Note:

 Junction-to-ambient thermal resistance is a function of application and board layout. This data is measured with fourlayer 1s2p boards in accordance to JESD51- JEDEC standard. Special attention must be paid not to exceed junction temperature T_{J(max)} at a given ambient temperate T_A.

Electrical Characteristics

Minimum and maximum values are at V_{IN} = 2.7 V to 5.5 V, T_A = -40°C to +85°C, C_{IN} = C_{OUT} = 4.7 μ F, L = 1 μ H, unless otherw ise noted. Typical values are at T_A = 25°C, V_{IN} =3.6 V.

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Units
Power Su	pplies					
	Quiescent Current	Device Not Switching, $EN=V_{IN}$		16		μA
lα		Device Switching, EN=V _{IN}		18	25	μA
I _(SD)	Shutdow n Supply Current	$V_{IN} = 3.6 V, EN = GND$		0.05	1.00	μA
M	Linder Valtage Leekout Threehold	Rising Edge	1.8		2.1	v
V_{UVLO}	Under-Voltage Lockout Threshold	Falling Edge	1.75		1.95	
V _(ENH)	Enable HIGH-Level Input Voltage		1.2			V
V _(ENL)	Enable LOW-Level Input Voltage				0.4	V
I _(EN)	Enable Input Leakage Current	$EN = V_{IN} \text{ or } GND$		0.01	1.00	μA
Oscillator		·	-		-	-
f _{osc}	Oscillator Frequency		2.5	3.0	3.5	MHz
Regulatio	n		-	-		
M		$I_{LOAD} = 0$ to 600 mA	1.775	1.820	1.865	V
Vo	Output Voltage Accuracy	CCM	1.784	1.820	1.856	V
t _{ss}	Soft-Start	EN = 0 -> 1			300	μs
Output Dr	iver		-	-		
D	PMOS On Resistance	$V_{IN} = V_{GS} = 3.6 V$		180		mΩ
R _{DS(on)}	NMOS On Resistance	$V_{IN} = V_{GS} = 3.6 V$		170		mΩ
I _{LIM}	PMOS Peak Current Limit	Open-Loop ⁽²⁾	650	800	900	mA
R _{DIS}	Output Discharge Resistance	EN = GND		700		Ω
T _{TSD}	Thermal Shutdow n	CCM Only		150		°C
T _{HYS}	Thermal Shutdow n Hysteresis			20		°C

Note:

2. The Electrical Characteristics table reflects open-loop data. Refer to Operation Description and Typical Characteristic for closed-loop data.

Operation Description

The FAN53501 is a step-down switching voltage regulator that delivers a fixed 1.82 V from an input voltage supply of 2.7 V to 5.5 V. Using a proprietary architecture with synchronous rectification, the FAN53501 is capable of delivering 600mA at over 90% efficiency, while maintaining a light load efficiency of over 80% at load currents as low as 1 mA. The regulator operates at a nominal frequency of 3 MHz at full load, which reduces the value of the external components to 1 μ H for the output inductor and 4.7 μ F for the output capacitor.

Control Scheme

The FAN53501 uses a proprietary non-linear, fixedfrequency PWM modulator to deliver a fast load transient response, while maintaining a constant switching frequency over a wide range of operating conditions. The regulator performance is independent of the output capacitor ESR, allowing for the use of ceramic output capacitors. Although this type of operation normally results in a switching frequency that varies with input voltage and load current, an internal frequency loop holds the switching frequency constant over a large range of input voltages and load currents.

For very light loads, the FAN53501 operates in discontinuous current (DCM) single-pulse PFM mode, which produces low output ripple compared with other PFM architectures. Transition betw een PWM and PFM is seamless, with a glitch of less than 14 mV at V_{OUT} during the transition betw een DCM and CCM modes.

Combined with exceptional transient response characteristics, the very low quiescent current of the controller (<16 μ A) maintains high efficiency, even at very light loads, w hile preserving fast transient response for applications requiring very tight output regulation.

Enable and Soft Start

Maintaining the EN pin LOW keeps the FAN53501 in nonswitching mode in which all circuits are off and the part draws ~50 nA of current. In addition, during shutdow n, FB is actively discharged to ground through a nominally 700 Ω path. Increasing EN above its threshold voltage activates the part and starts the soft-start cycle. During soft start, the current limit is increased in discrete steps so that the inductor current is increased in a controlled manner. This minimizes any large surge currents on the input and prevents any overshoot of the output voltage.

Under-Voltage Lockout

When EN is HIGH, the under-voltage lockout keeps the part from operating until the input supply voltage rises high enough to properly operate. This ensures no misbehavior of the regulator during startup or shutdow n.

Current Limiting

A heavy load or short circuit on the output causes the current in the inductor to increase until a maximum current threshold is reached in the high-side switch. Upon reaching this point, the high-side switch turns off, preventing high currents from causing damage.

The peak current limit shown in Figure 14, $I_{\text{LIM(PK)}}$ is slightly higher than the open-loop tested current limit, $I_{\text{LIM(OL)}}$, in the Electrical Characteristics table. This is primarily due to the effect of propagation delays of the IC current limit comparator.

Thermal Shutdown

When the die temperature increases, due to a high load condition and/or a high ambient temperature, the output switching is disabled until the temperature on the die has fallen sufficiently. The junction temperature at which the thermal shutdown activates is nominally 150°C with a 20°C hysteresis.

Applications Information

Selecting the Inductor

The output inductor must meet both the required inductance and the energy handling capability of the application.

The inductor value affects the average current limit, the PWM-to-PFM transition point, the output voltage ripple, and the efficiency.

The ripple current (ΔI) of the regulator is:

$$\Delta I \approx \frac{V_{OUT}}{V_{IN}} \bullet \left(\frac{V_{IN} - V_{OUT}}{L \bullet f_{SW}} \right)$$
(1)

The maximum average load current, I_{MAX(LOAD)} is related to the peak current limit, ILIM(PK) (see Figure 14) by the ripple current:

$$I_{MAX(LOAD)} = I_{LIM(PK)} - \frac{\Delta I}{2}$$
(2)

The transition between PFM and PWM operation is determined by the point at which the inductor valley current crosses zero. The regulator DC current when the inductor current crosses zero, I_{DCM}, is:

$$I_{\text{DCM}} = \frac{\Delta I}{2} \tag{3}$$

The FAN53501 is optimized for operation with L=1µH, but is stable with inductances ranging from 700nH to 3.0 µH. The inductor should be rated to maintain at least 80% of its value at ILIM(PK).

Efficiency is affected by the inductor DCR and inductance value. Decreasing the inductor value for a given physical size typically decreases the DCR; but since ΔI increases, the RMS current increases, as do the core and skin effect losses.

$$I_{\text{RMS}} = \sqrt{I_{\text{OUT}(\text{DC})}^2 + \frac{\Delta I^2}{12}}$$
(4)

The increased RMS current produces higher losses through the $R_{\text{DS}(\text{ON})}$ of the IC MOSFETs as well as the inductor ESR.

Increasing the inductor value produces lower RMS currents, but degrades transient response. For a given physical inductor size, increased inductance usually results in an inductor with low er saturation current.

Table 1 shows the effects of inductance higher or low er than the recommended 1μ H on regulator performance.

Output Capacitor

Table 2 suggests 0603 capacitors. 0805 capacitors may further improve performance in that the effective capacitance is higher and ESL is low er than 0603. This improves the transient response and output ripple.

Increasing C_{OUT} has no effect on loop stability and can therefore be increased to reduce output voltage ripple or to improve transient response. Output voltage ripple, ΔV_{OUT} , is:

$$\Delta V_{OUT} = \Delta I \bullet \left(\frac{1}{8 \bullet C_{OUT} \bullet f_{SW}} + ESR \right)$$
(5)

Input Capacitor

The 4.7 μ F ceramic input capacitor should be placed as close as possible to the VIN pin and GND to minimize the parasitic inductance. If a long wire is used to bring power to the IC, additional "bulk" capacitance (electrolytic or tantalum) should be placed between C_{IN} and the power source lead to reduce ringing that can occur between the inductance of the pow er source leads and C_{IN}.

Table 1. Effects of Inductor Value Changes (from 1µH Recommended) on Regulator Performance

Inductor Value	I _{MAX(LOAD)} EQ. 2	I _{LIM(PK)}	ΔV_{OUT} EQ. 5	Transient Response
Increase	Increase	Decrease	Decrease	Degraded
Decrease	Decrease	Increase	Increase	Improved

PCB Layout Guidelines

For the bill of materials of the FAN53501 evaluation board, see Table 2. There are only three external components: the inductor and the input and output capacitors. For any buck switcher IC, including the FAN53501, it is always important to place a low-ESR input capacitor very close to the IC, as shown in Figure 5. That ensures good input decoupling, which helps reduce the noise appearing at the output terminals and ensures that the control sections

of the IC do not behave erratically due to excessive noise. This reduces switching cycle jitter and ensures good overall performance. It is not considered critical to place either the inductor or the output capacitor very close to the IC. There is some flexibility in moving these two components further away from the IC.

Desc	ription	Qty.	Ref.	Vendor	Part Number
	1.2μH, 1.8A, 55m Ω			ТОКО	1117AS-1R2M
Inductor	1.3μH, 1.2A, 90mΩ	1	L1	FDK	MIPSA2520D1R0
	1.5μH, 1.3A			Taiyo Yuden	CBC3225T15MR
Capacitor 4.7 μ F, ±10	Capacitor 4.7µF, ±10%, 6.3V, X5R, 0603		$C_{\rm IN}, C_{\rm OUT}$	MURATA	GRM39 X5R 475K 6.3
IC DC/DC Regulator in CSP, 5 bumps		1	U1	ON Semiconductor	FAN53501UCX
Load Resistor (Option	Load Resistor (Optional)		R _{LOAD}	Any	

 Table 2. Evaluation Board Bill of Materials (optional parts are installed by request only)

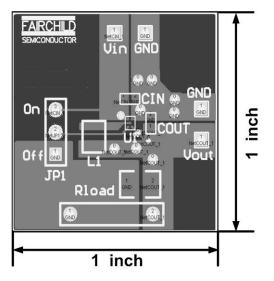


Figure 5. Evaluation Board PCB

Feedback Loop

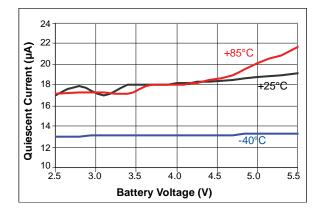
One key advantage of the non-linear architecture is that there is no traditional feedback loop. The loop response to changes in V_{OUT} is essentially instantaneous, which explains its extraordinary transient response. The absence of a traditional, high-gain compensated linear loop means that the FAN53501 is inherently stable over a wide range of L_{OUT} and C_{OUT} .

 L_{OUT} can be reduced further for a given application, provided it is confirmed that the calculated peak current for the required maximum load current is less than the minimum of the closed-loop current limit. The advantage is that this generally leads to improved transient response, since a small inductance allows for a much faster increase in current to cope with any sudden load demand.

The inductor can be increased to 2.2 μH ; but, for the same reason, the transient response gets slightly degraded. In that case, increasing the output capacitor to 10 μF helps significantly.

Typical Performance Characteristics

 V_{IN} = 3.6V, T_A = 25°C, V_{EN} = V_{IN} , according to the circuit in Figure 1, unless otherwise specified.



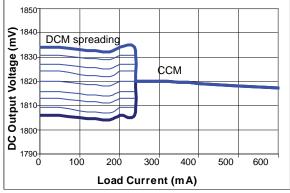


Figure 6. Quiescent Current vs. Battery Voltage

Figure 7. Load Regulation, Increasing Load

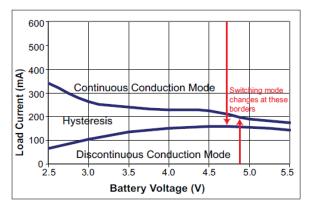


Figure 8. Switch Mode Operating Areas

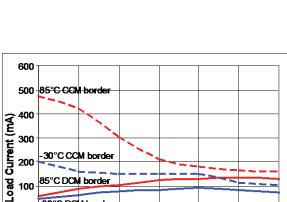


Figure 9. Switch Mode Over Temperature

Battery Voltage (V)

4.0

4.5

5.0

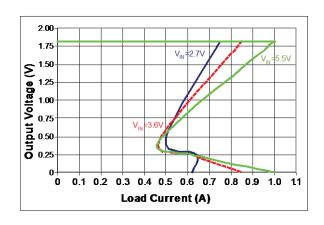
5.5

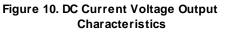
3.5

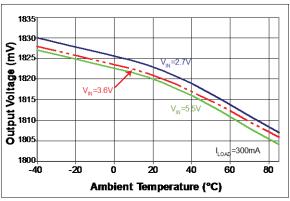
30°C DCM border

3.0

0 | 3 2.5

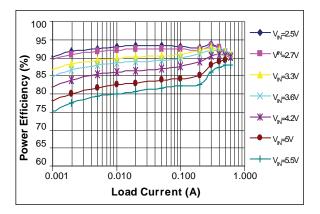








Typical Performance Characteristics (Continued) V_{IN} = 3.6V, T_A = 25°C, V_{EN} = V_{IN} , according to the circuit in Figure 1, unless otherwise specified.



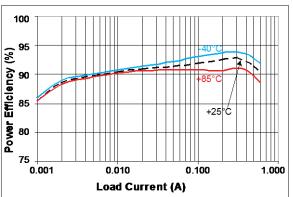


Figure 12. Power Efficiency vs. Load Current



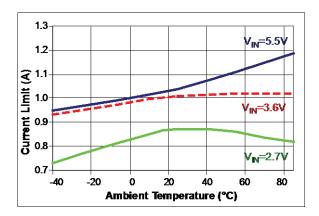
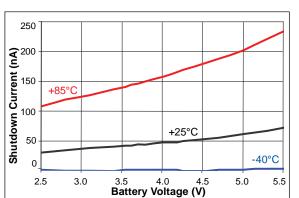
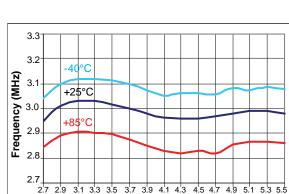


Figure 14. PMOS Current Limit in Closed Loop





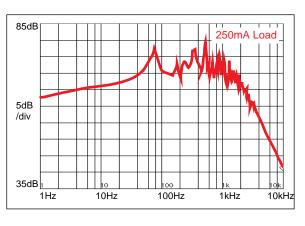


Figure 16. Power Supply Rejection Ratio in CCM

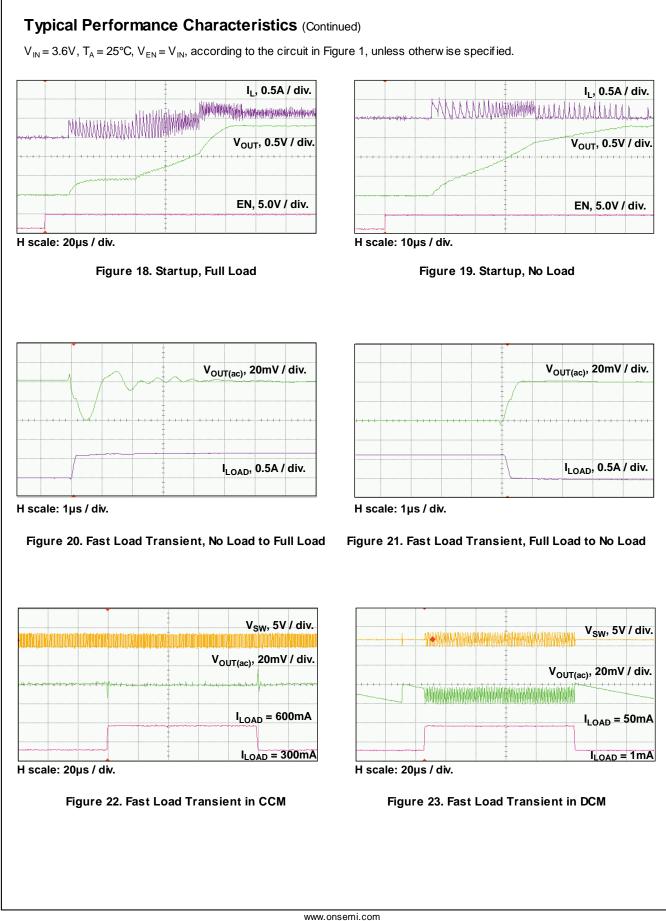
Figure 17. Switching Frequency in CCM

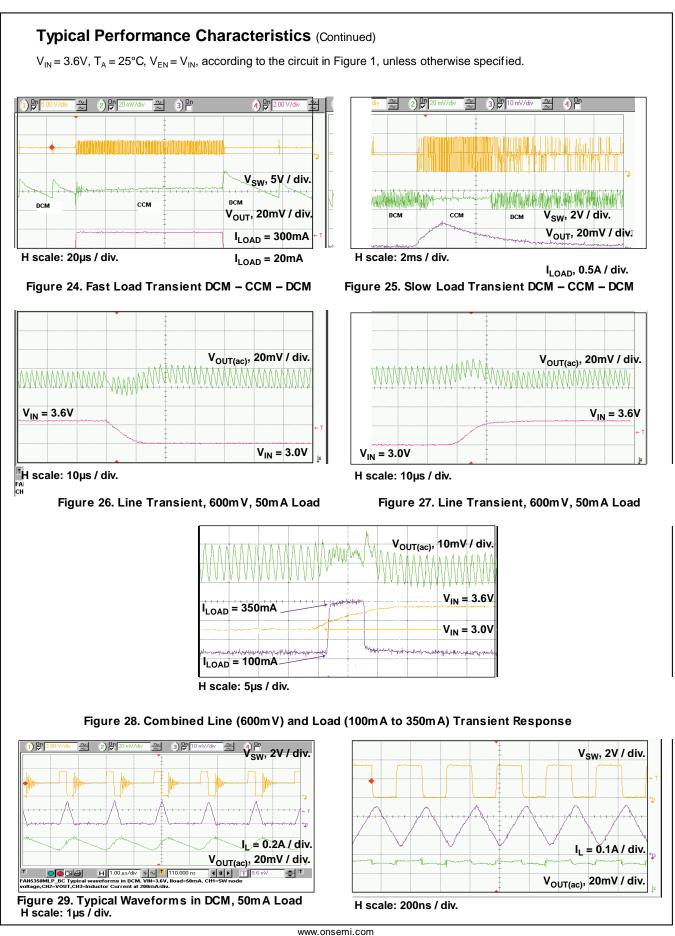
Battery Voltage (V)

Battery Voltage

Figure 15. Shutdown Supply Current vs.

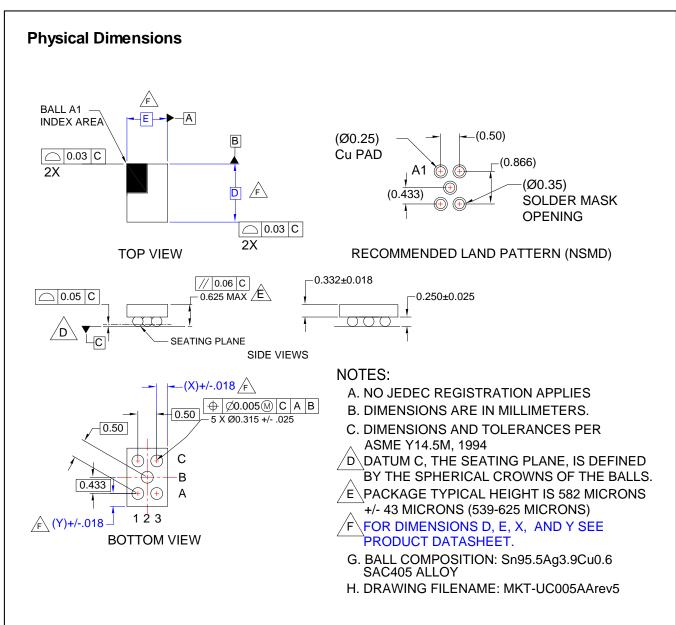






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FAN53501 — 3MHz, 600mA Step-Down DC-DC Converter in Wafar-I gvel Chip-Scale Pack



Product-Specific Dimensions

Product	D	E	Х	Y
FAN53501UCX	1.350 +/- 0.040	0.980 +/- 0.040	0.242	0.244

Figure 31. 5-Bump Wafer-Level Chip-Scale Package (WLCSP)

Package drawings are provided as a service to customers considering ON Semiconductor components. Drawings may change in any manner without notice. Please note the revision and/or date on the drawing and contact a ON Semiconductor representative to verify or obtain the most recent revision. Package specifications do not expand the terms of ON Semiconductor's worldwide terms and conditions, specifically the warranty therein, which covers ON Semiconductor products.

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